# AWARD ACCOUNTS SPSJ Award Accounts Material Design and Manufacture of a New Thermoplastic Polyester Elastomer

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Two novel thermoplastic polyester elastomer (TPEE) were developed. One is an alloy of TPEE and SBC (styrene block copolymer). It exhibits a low <u>compression set</u> (Cs), high softness and high adhesiveness to PS (polystyrene), ABS (acrylonitrile butadiene styrene copolymer), PC (polycarbonate), etc. Adhesion after double injection is extremely stable and durable. By these alloys, many new superimposed products can be produced easily with double injection.

The other is TPEE modified by the grafting of an acid-anhydride group. It bonds polyester to PA (polyamide) or EVOH (ethylene vinylalcohol copolymer) with sufficient adhesion even at elevated temperatures (80–120 °C). These properties have been used to create many new multi-layer products. This modified TPEE also improves properties of PA or EVOH, such as pinhole resistance.

These materials contribute to the reduction of environmental loads and enhance flexibility of superimposed article shape. The SPSJ Award was given to mark the originality of this new adhesive elastomer and its contribution to producing superimposed articles.

KEY WORDS: Thermoplastic Polyester Elastomer / Styrene Block Copolymer / Polymer Alloy / Adhesion / Graft Polymer / Acid Anhydride /

Many thermoplastic elastomers (TPE) are widely used owing to good formability and elasticity.

Recently, double-injection technology, which combines more than two plastics, has been developed for assembled plastic products. Some TPEs are used to impart soft tactile properties or seal electric appliances or automotive parts. But alternative plastics are of limited use because of poor adhesion property.

TPEE composed of PBT (polybutylene terephthalate) as the hard segment, and amorphous poly(alkylene glycol), typically PTMG (poly tetramethylene glycol), as the soft segment, exhibits mechanical strength, high heat resistance and the ability to adhere to many plastics, such as PS, ABS, PC, etc. The typical structure of TPEE is illustrated in Figure 1.

TPEE has some drawbacks such as hardness and large compression set(Cs). Although SBC is disadvantageous because of its poor heat resistance, it has excellent softness and Cs. The creation of an elastomer with the advantages of TPEE and SBC is desired to expand the utility of TPEE industrially. This study thus developed TPEE which possesses softness and good adhesion.

There is large demand in the field of food packaging for an adhesive resin to bind polyester with gas barrier resins. Polyester exhibits mechanical strength, high gloss and transparency, high heat resistance and good aroma retention, but polyester is difficult to bond. To maintain heat resistance during retort in the dry-lamination process, adhesive agents which contain much organic solvent are required. Adhesion resins for co-extrusion, a process in which organic solvent is not used, have poor heat resistance since they contain elastomer and tackifier. The authors thus developed an adhesive resin which bind polyester to gas barrier resins even at elevated temperatures without using an organic solvent. An acidanhydride-modified TPEE which bind polyester to gas barrier resins was made.

This article introduces two newly developed TPEE, TPEE/ SBC alloy and modified TPEE having excellent adhesive properties.

#### TPEE/SBC ALLOY

The authors produced a new alloy with the advantages of TPEE and those of SBC. This alloy has not only excellent Cs and softness, but excellent adhesiveness to PS, ABS and PC.

The mechanism of adhesion is not clear but possibly is an interaction between the ether group at the PTMG segment and the aromatic ring in PS (or PC segments). It is well known that the binary blend of PS and PVME (poly(vinyl methyl ether)) is miscible and many reports have been published on mechanism for interactions.

AWARD ACCOUNTS

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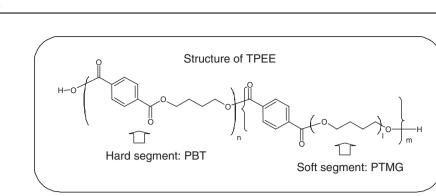


Figure 1. Typical structure of TPEE.

F. J. Lu *et al.* reported<sup>1</sup> that there is interaction between the ether group and aromatic ring of PS, based on the change in IR spectra of miscible and immiscible PS/PVME films.

Polymer

Nemoto *et al.*<sup>2</sup> calculated the diffusion coefficient and reported interaction between PS and PVME based on NMR analysis,<sup>3,4</sup> suggesting that the phenyl ring is much closer to the methyl group of PVME than to the main chain carbons of PS.

H. Shimizu<sup>5</sup> *et al.* observed the blend of PS and PVME to be a homogeneous structure when lower-Mn PS is used, while a nanoheterogeneous structure with high-Mn PS, according to TSDC (thermally stimulated depolarization current) and TEM findings.

From these reports on interactions between PS and PVME, comparable interactions may occor between PTMG and PS based on the analogical structures of PVME and PTMG.

There are several reports on interactions or miscibility between other polymers, such as PBT/PC or poly(alkylene ether)/PMMA. Detailed mechanisms of the interactions between other polymers are not clear, and significant interactions may exist between PBT or PTMG segments and other polymers to lead improvement in adhesion and miscibility.

#### Morphology of the TPEE/SBC Alloy

Figure 2 shows a TEM photograph of the TPEE/SBC alloy. The PS domains are stained in black by  $RuO_4$ . SBC domains were observed to be less than 1 micron in diameter, indicating a finely dispersed morphology. The lamellar structure of PBT segments in the matrix, the micro-phase separated structure of the SBC domain and irregularity along the interface of the matrix/domain were observed. The convex parts stained in black, which may indicate PS microdomains, were found to significantly interact with PTMG in the TPEE matrix.

#### **Properties of the TPEE/SBC Alloy**

The mechanical and adhesive properties of the alloy can be controlled by the type and amount of TPEE, SBC and extender oil. Figure 3 shows the balance of softness and Cs.<sup>6</sup> The TPEE/SBC alloy covers the region of higher softness and lower Cs than the softest TPEE. The softest alloy showed a Shore A hardness score of 55 and a Cs score of 55 (70 °C, 22 h). Technical features:

#### a) Softness

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The addition of softer TPEE (high content PTMG), softer SBC

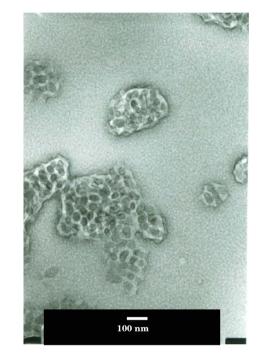


Figure 2. TEM photograph of TPEE/SBC/oil alloy stained with RuO<sub>4</sub>. TPEE: PTMG (70 wt %) + PBT (30 wt %): 80 wt %. SEBS+oil: 20 wt %.

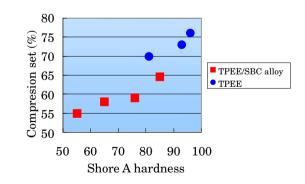


Figure 3. Balance of the compression set and the softness in comparison with that of pure TPEE. Conditions for compression measurement: 70 °C, 22 hrs.

(suitable PS content and micro-structure of the mid-segment) and extender oil is desirable.

# b) Low Cs

High-molecular-weight SBC is necessary.

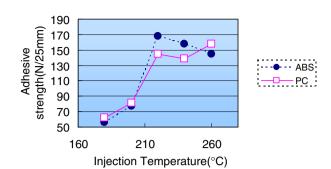


Figure 4. Injection temperature dependency of adhesive strength. TPEE/ SBC alloy Shore A hardness score, 67.

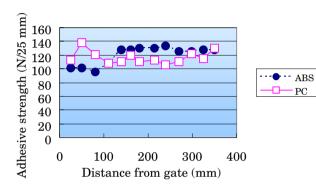


Figure 5. Adhesive strength at various distances from gate. TPEE/SBC alloy Shore A hardness score 67.

### c) Adhesion strength

More than the limited content of PTMG is required.

The properties are controlled as described above. Controlling the viscosity of the matrix and domain and choosing the best processing conditions are important.

#### Adhesion Strength of the TPEE/SBC Alloy

The adhesion strength of specimens prepared by insert injection is measured as follows: a preformed sheet of ABS or PC, 2 mm in thickness, is inserted in the mold, and then a TPEE/SBC alloy sheet 2 mm in thickness of is injected into the mold at various temperatures. Peeling strength was measured at a peeling rate of 200 mm/min in the 180° direction. Figure 4 indicates peeling strength even at injection temperature higher than 220 °C to be over 100 N/25 mm, which would be difficult manually.

Deviation of the peeling strength was small across the length of flow from the gate to the end (350 mm), as shown in Figure 5.

Adhesion strength hardly decreased after 1000 h of heat resistance testing, 200 heat-shock cycles and 1000 h of humidity testing (Table I). Retention of adhesion strength after the humidity test indicated hydrogen bonding not to contribute to interactions between PS and TPEE.

#### Polymers Which Can Be Adhered to the TPEE/SBC Alloy

The polymers which can be adhered to TPEE/SBC alloy are summarized in Table II along with PS families, PC and their alloys, as well as thermo-setting resin, such as phenol resin or

Table I. Durability of adhesion strength under various conditions

Resin	Original strength	Heat 80 °C 1000 h	Heat shock test -40-80 °C 200 cycles	Humidity resistance 50°C, 95% RH 1000 h
ABS	230	160	150	210
PC	200	150	200	200
				(Unit: N/cm)

TPEE/SBC alloy Shore A hardness score, 67.

Table II. Polymers which can be adhered

Resin	Example
Polycarbonate	PC
Polystyrene	ABS, AES, AS, GPPS, HIPS
Polyphenylether	PPE/HIP
Acrylate resin	PMM
Polyester	PET, PBT
Polymer	PC/ABS, PC/PET, PC/PBT
Thermosetting	Phenol Unsaturated polyester

unsaturated polyester resin. Polyesters such as PET and PBT also adhere to the TPEE/SBC alloy owing to the compatibility of the hard segment in TPEE.

The mechanism of adhesion to PC is not clear, but possibly may be interacted between the aromatic ring and ether, as in the case of PS and PTMG.

### **TPEE/SBC** Alloy Usage

Using interactions between PS and TPEE, various articles can be formed easily by double-injection molding, instead of by adhesive agents which take much time. Example samples are shown in Figure 6.

All samples were formed by ABS or PS injection first, and then TPEE/BC alloy injection.

Using TPEE/SBC alloy packing materials to seal interior, operation buttons on precision components, compact appliances and tools were made.

#### ACID-ANHYDRIDE-GRAFTED TPEE

The TPEE/SBC alloy adheres to many plastics though not polyamide (PA) and ethylene-vinyl alcohol copolymer (EVOH).

To solve problems in food packaging, we grafted acid anhydride onto TPEE by reactive processing using peroxide in the molten state.<sup>7,8</sup> This TPEE modified with acid anhydride bind polyester to PA and EVOH. It is not unusual to graft acid anhydride onto polyolefin. But it seems impossible to graft acid anhydride onto polyester; in fact, TPEE, which has less PTMG, cannot be grafted with sufficient adhesiveness.

A schematic adhesion mechanism is given in Figure 7. The compatibility of the PBT segment of TPEE with polyester makes possible bonding between TPEE and polyester. The acid-anhydride group binds modified TPEE with gas barrier

# Polymer Journal



(a)



(b)



(c)

Figure 6. (a) Water-proof cameras. TPEE/SBC alloy on ABS. Seal-packing. (b) Goggles. TPEE/SBC alloy on PC. Soft tactile properties. (c) Grip of ball-point pens. TPEE/SBC alloy on ABS. Soft grip.

resins by chemical bonds or through chemical interaction. Obviously, strong adhesion to PS is maintained.

Modified TPEE features::

1) content of the PTMG segment in TPEE should be larger than 50 wt %.

2) molecular weight slightly smaller than that of the original polymer.

3) acid-anhydride grafting point possibly the  $\alpha$ -position of the PTMG segment in TPEE. The grafting point is the  $\alpha$ -position when reacting maleic acid anhydride with poly-THF using peroxide.<sup>9</sup>

Modified TPEE has been registered as a new chemical substance in the Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substances (Japan),<sup>10</sup> as well as in the positive list approved by the Japan Hygienic Olefin and Styrene Plastics Association.

# Adhesion Strength of TPEE Modified with Acid Anhydride

A three-layer film consisting of PBT, adhesive resin and PA6 or EVOH  $(32/8/32 \,\mu\text{m})$  was produced by cast coextrusion, and adhesion strength between the adhesive resin and PA6 or EVOH was measured. The adhesive resin as reference was a commercially available resin for the coextrusion of PET/EVOH, composed of olefinic elastomer and tackifier. At ambient temperature, modified TPEE had much greater adhesiveness than the reference, as shown in Figure 8. At 80 or 120 °C, the temperatures corresponding to the boiling and the retort, respectively, the reference lost its adhesion strength, whereas the modified TPEE retained adhesion strength at more than 1 N/cm, which is sufficient for food packaging film.<sup>11,12</sup>

The modified TPEE makes possible to produce materials for multi-layered film by co-extrusion, without releasing VOCs (volatile organic compounds) as in the dry lamination method or extrusion lamination using AC (anchor coat) agent.

# ESCA Analysis of the Adhesion Interface

The chemical structure of the interface between EVOH and modified TPEE was analyzed by ESCA (electron spectroscopy for chemical analysis). Figure 9 shows typical C1s ESCA signals of the surface. Each signals was assigned using a database.<sup>13</sup> Three major binding energy peaks at 286, 290 and 292 eV were attributed to C1s electron adjacent to carbon, oxygen and the carbonyl C1s electron, respectively. On the surface of EVOH after the peel-off, a COO-attached carbon peak (292 eV), not observed in the original EVOH, appeared. The peak area ratios of oxygen-attached carbon (290 eV) to the hydrogen-attached carbon (286 eV) became larger than in the original EVOH. Cohesive failure of the modified TPEE thus occurs and it partially covers the surface of EVOH.

## Adhesiveness of the Modified TPEE to Metal

The modified TPEE adheres to many metals, such as SUS304, zinc-galvanized sheet iron or aluminum, as summarized in Table III. Layered products consisting of metal and polyester can thus be produced.

## Efficacy of Polymer Modification

Gas barrier resins usually have high modulus and brittleness, because their molecules are densely packed. Certain properties of EVOH could be improved by adding modified TPEE.

**Flexural Modulus and Impact Strength.** Figure 10 shows the Izod impact strength of EVOH to increase in proportion to modified TPEE, and the obtained resins soften with modified TPEE.

**Morphology.** Figure 11b shows a TEM photograph of binary material composed of EVOH ( $32 \mod \%$  ethylene) and modified TPEE (90/10). In contrast to un-modified TPEE in Figure 11a, a finer dispersion at the sub-micron level can be seen. The

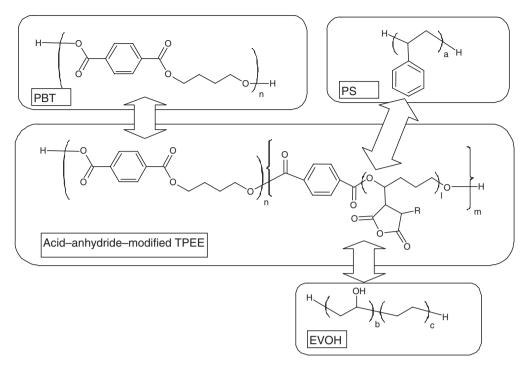


Figure 7. Schematic interactions between modified TPEE and other polymers.

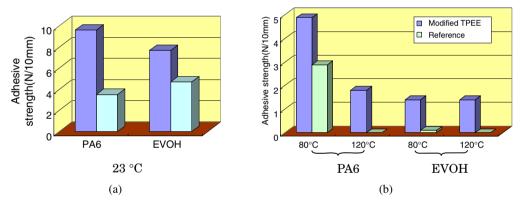


Figure 8. Adhesion strength of modified TPEE against PA6 or EVOH. (a) Ambient temperature, (b) elevated temperatures. Peeling rate: 100 mm/min. Peeling direction: MD (machine direction).

grafted acid derivatives seem apparently reduce interface tension.

**Transparency and Oxygen Permeability.** Modified TPEE was so finely dispersed that transparency was not significantly influenced and nor did barrier properties much. Increase in oxygen permeability was limited since modified TPEE was dispersed into small separate domains in the EVOH matrix, as shown in Figures 12 and 13.

**Pinhole Defect Resistance.** Rremarkable pinhole defect resistance was observed in the Gelboflex tester. By adding only 5 wt % modified TPEE to EVOH, the number of pinholes was reduced without significant change in the gas barrier and transparency, as shown in Figure 14.

**Improvement in Formability.** Improvement in EVOH formability was confirmed by cup-shape SPPF (solid-phase pressure forming). The shaded portion in Figure 15 shows the

moldable area without cracks. Although EVOH forms only at a certain temperature, the moldable temperature range is enhanced with increase in modified TPEE.

#### **Example of Modified TPEE Usage**

Modified TPEE may be used as an adhesive resin.

a) Tubes composed of PET/modified TPEE/EVOH/adhesive resin/PE.

Tubes for transferring juice must have good aroma retention and so PET is used as the inner layer. Whitening occurs in the case of conventional adhesive resins due to low adhesive strength, but tubes lined with modified TPEE can be bent without whitening.

b) Multi-layered films

In films modified TPEE is used owing to superior adhesion, high transparency, and absence of gel formation.

# Polymer Journal

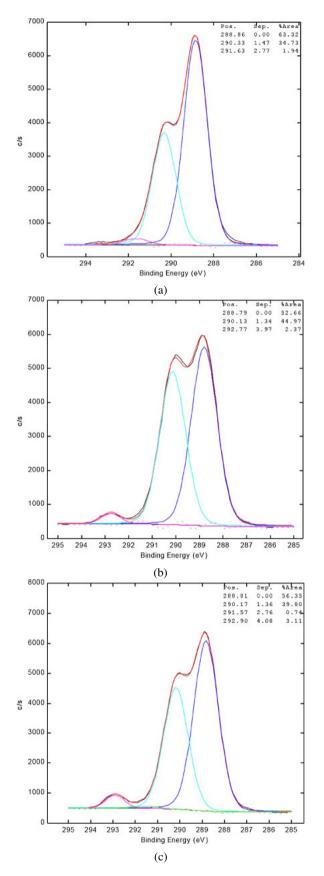


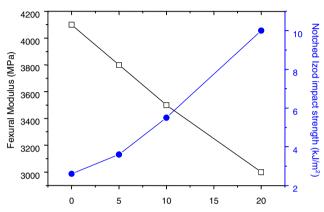
Figure 9. C1s spectra, as found by ESCA. (a): Original EVOH. (b): Original modified TPEE. (c): EVOH surface after peel-off.

Table III. Adhesion strength of modified TPEE on various metals

	Press temperature (°C)		
Metal	160	180	200
SUS304	1.5	7	29
Zinc-galvanized sheet iron	10	31	46
Aluminum	15	36	39
			(1 1 1+- N1/)

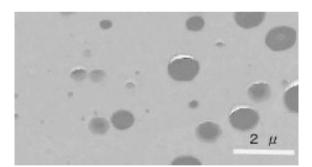
(Unit: N/cm)

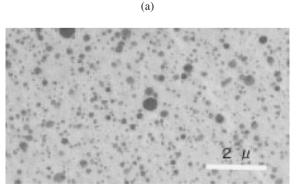
Pressing conditions: heating time, 7 min without pressure and 3 min at 1 MPa. Measurement conditions: 180° peel at 20 mm/min.



Wt% of modified TPEE in binary composite with EVOH (44 mol% ethylene)

Figure 10. Impact strength and softness of EVOH improved by addition of modified TPEE. Flexural modulus and Izod impact measured at 23°C, 50% RH (relative humidity). Content of soft segment in modified TPEE: 60 wt %.





(b)

Figure 11. Morphology, as found by TEM. (a): EVOH/unmodified TPEE = (90/10). (b): EVOH/modified TPEE = (90/10).

6

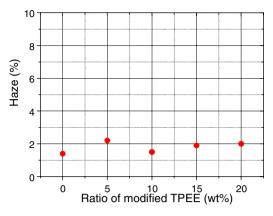


Figure 12. Haze in binary composite of EVOH and modified TPEE. EVOH: 32 mol % ethylene.

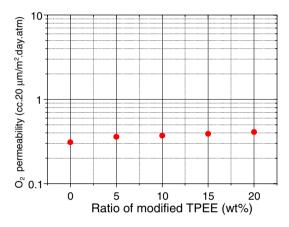


Figure 13. Oxygen permeability of binary composite of EVOH and modified TPEE. Measurement conditions: 23 °C, 50% RH (relative humidity).

- PS/modified TPEE/PET
- PET/modified TPEE/EVOH
- PET/modified TPEE/PVC

Further applications of modified TPEE are expected.

# SOCIAL APPLICATIONS

1) Reduction environmental loads.

TPEE/SBC alloy and acid-anhydride-modified TPEE make possible reduction of the environmental loads.

(1) The double-injection method without adhesive containing organic solvent reduces VOCs.

(2) Co-extrusion laminated films reduce VOCs considerably, compared to the dry-lamination method.

VOC can be reduced is about 3.5 times that of modified TPEE used, as a rough estimation, assuming that a) the solid content of the adhesive for dry lamination is 30 wt %, b) the amount of adhesive used is  $10 \text{ g/m}^2$  (conditions are based on the Japan Polyethylene Lamination Products Industrial Association report), and c)  $2 \mu$ m-thick modified TPEE sheets are used to make co-extrusion film.

(3) Decrease in aluminum, which requires much energy to

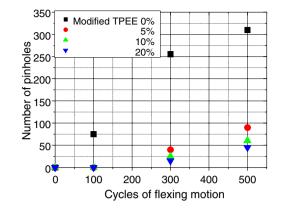


Figure 14. Results of Gelboflex test: the pin-hole reduction by adding modified TPEE. Measurement conditions: Film: blown film, 30 μm in thickness, 100 mm in length. Stroke: 2.5 inch. Rotation: 440°. Atmosphere: 23 °C, 50% RH (relative humidity). EVOH: 32 mol % ethylene.

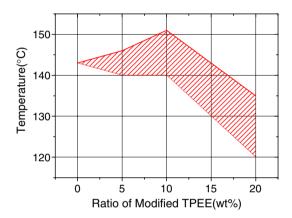


Figure 15. Improvement in formability by modified TPEE addition. Sheets 300 μm in thickness formed into cup shape by SPPF. Shaded part indicates surface temperature at which the material is moldable without cracking. EVOH: 44 mol% ethylene.

produce and has higher density than plastics, reduces environmental loads.

# Recycling

(1) Silica-coated PET film serves as a gas barrier comparable with that of aluminum foil, but it is difficult to adhere to other materials. However, it can be a good substitute for aluminum if an efficient adhesive is used. This adhesive is modified TPEE with this adhesive, recycling efficiency should improve.

(2) TPEE/SBC alloy and modified TPEE interact with various polymers, and contain soft segments. They thus have high potential as recycling agents as impact modifiers.

2) Improvement in reliability

(1) Remarkable reduction in pinholes in the multi-layer film promotes the reliability of film as food packing material.

(2) Packing material made by double injection has higher reliability than that made by manually.

3) Increase in shape flexibility

Flexibility in the shape of the superimposed article greatly

# Polymer Journal

increases by double injection. This should help satisfy the demand for diversification in various material application.

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